

Description

The FMEN-210B is a 150 V, 10 A Schottky diode with allowing improvements in V_F and I_R characteristics.

These characteristic features contribute to improving power supply efficiency and to enabling high-frequency systems.

Features

• V _{RM}		150 V
• I _{F(AV)}		10 A
• $V_F (I_F = 5 A)$		0.87 V tvp.
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- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

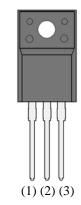
Applications

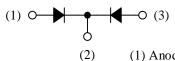
High speed switching applications as follows:

- DC-DC Converter
- Adapter

Package

TO220F-3L





- (1) Anode
 - (2) Cathode
 - (3) Anode

Not to scale

FMEN-210B

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage ⁽¹⁾	V_{RSM}		150	V
Repetitive Peak Reverse Voltage ⁽¹⁾	V_{RM}		150	V
Average Forward Current	I _{F(AV)}	See Figure 1 and Figure 2	10	A
Surge Forward Current ⁽¹⁾	I_{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	100	A
I ² t Limiting Value ⁽¹⁾	I ² t	$1 \text{ ms} \le t \le 10 \text{ ms}$	50	A^2s
Junction Temperature	$T_{\rm J}$		-40 to 150	°C
Storage Temperature	T_{STG}		-40 to 150	°C

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop ⁽¹⁾	V_{F}	I _F = 5 A	_	0.87	0.92	V
Reverse Leakage Current ⁽¹⁾	I_R	$V_R = V_{RM}$	_	_	100	μΑ
Reverse Leakage Current under High Temperature ⁽¹⁾	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 ^{\circ}C$	_	_	25	mA
Thermal Resistance ⁽²⁾	R _{th(J-C)}		_	_	4.0	°C/W

Mechanical Characteristics

Parameter	Conditions	Min.	Typ.	Max.	Unit
Heatsink Mounting Screw Torque		0.490		0.686	N·m

⁽¹⁾ Specifies a value per chip; the FMEN-210B consists of two chips.

 $^{^{(2)}}$ $R_{th (J-C)}$ is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

Rating and Characteristic Curves

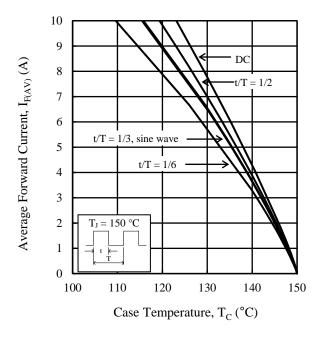


Figure 1. Typical Characteristics: $I_{F(AV)}$ vs. T_{C} $(V_{R}=0\ V)$

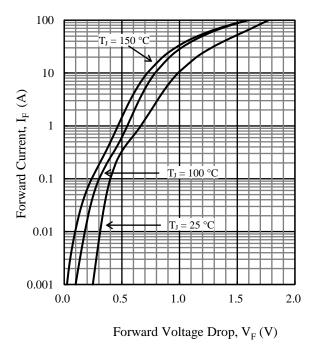


Figure 3. Typical Characteristics: I_F vs. V_F

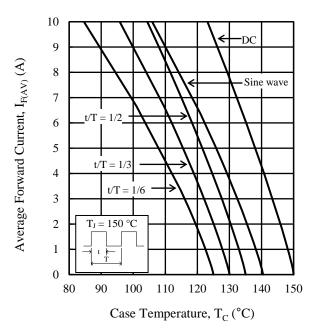


Figure 2. Typical Characteristics: $I_{F(AV)}$ vs. T_C ($V_R = 150 \ V$)

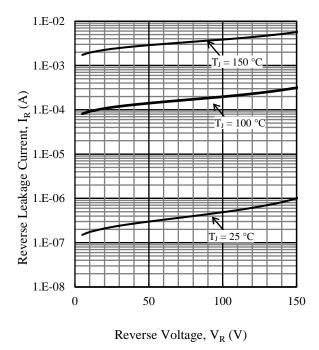
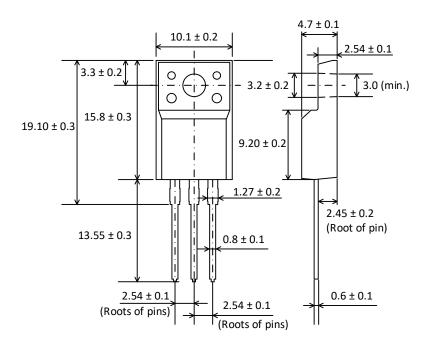


Figure 4. Typical Characteristics: I_R vs. V_R

Physical Dimensions

• TO220F-3L



NOTES:

- Dimensions in millimeters
- All the dimensions exclude mold flashes.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:

Flow: $260 \pm 5 \, ^{\circ}\text{C} / 10 \pm 1 \, \text{s}, 2 \, \text{times}$

Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time

Soldering should be at a distance of at least $1.5\ \mathrm{mm}$ from the body of the product.

Marking Diagram

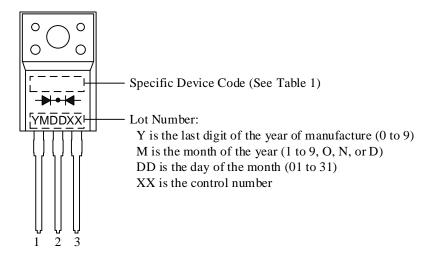


Table 1. Specific Device Code

Specific Device Code	Part Number
EN210B	FMEN-210B

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